

## **AMENDMENTS TO THE CLAIMS**

**Claim 1 (Currently Amended)** A copper-clad laminate of a glass fabric/thermosetting resin base material, the laminate having a small-diameter hole having a diameter of 0.15 mm or less formed by irradiation with a carbon dioxide gas laser, which base material is formed of prepreg obtained by impregnating a glass fabric base material made of a glass woven fabric having a thickness of 25 to ~~150~~ 40  $\mu\text{m}$ , a weight of 15 to ~~165~~ 27  $\text{g/m}^2$  and a gas permeability of 1 to 20  $\text{cm}^3/\text{cm}^2/\text{sec.}$ , with a thermosetting resin composition being dissolved in a solvent and drying it, wherein the thermosetting resin composition in the copper-clad laminate contains an insulating inorganic filler in an amount of 10 to 80 % by weight based on said resin composition.

**Claim 2 (Canceled)**

**Claim 3 (Previously Presented)** The copper-clad laminate according to claim 1, wherein the prepreg has a glass content of 25 to 70 % by weight.

**Claim 4 (Previously Presented)** The copper-clad laminate according to claim 1, wherein a glass fabric/thermosetting resin base material layer of the copper-clad laminate has a thickness of 30 to 150  $\mu\text{m}$ .

**Claim 5 (Previously Presented)** The copper-clad laminate according to claim 1, wherein the thermosetting resin composition is a resin composition containing, as an essential component, a polyfunctional cyanate ester and a prepolymer of said polyfunctional cyanate ester.